

MOS FIELD EFFECT TRANSISTOR 2SJ649

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

The 2SJ649 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

• Low on-state resistance:

 $R_{DS(on)1} = 48 \text{ m}\Omega \text{ MAX.} (V_{GS} = -10 \text{ V}, \text{ ID} = -10 \text{ A})$

 $R_{\text{DS(on)2}}$ = 75 m Ω MAX. (Vgs = -4.0 V, ID = -10 A)

Low input capacitance:

 $C_{iss} = 1900 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V})$

Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Drain to Source Voltage (VGs = 0 V)	Vdss	-60	V
Gate to Source Voltage ($V_{DS} = 0 V$)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	∓20	А
Drain Current (pulse) ^{Note1}	D(pulse)	∓70	А
Total Power Dissipation (Tc = 25°C)	Рт	25	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	-20	А
Single Avalanche Energy Note2	Eas	40	mJ

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ649	Isolated TO-220

(Isolated TO-220)



Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = -20 \rightarrow 0 V

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ELECTRICAL CHARACTERISTICS (TA = 25°C)

Characteristics	Symbol	Test Condtions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	ldss	Vds = -60 V, Vgs = 0 V			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓10	μA
Gate Cut-off Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	yfs	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	10	20		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = −10 V, Id = −10 A		38	48	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		47	75	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		1900		pF
Output Capacitance	Coss	Vgs = 0 V		350		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		140		pF
Turn-on Delay Time	td(on)	$V_{DD} = -30 \text{ V}, \text{ Id} = -10 \text{ A}$		10		ns
Rise Time	tr	Vgs = -10 V		10		ns
Turn-off Delay Time	td(off)	Rg = 0 Ω		73		ns
Fall Time	tr			17		ns
Total Gate Charge	QG	$V_{DD} = -48 V$		38		nC
Gate to Source Charge	Q _{GS}	Vgs = -10 V		7		nC
Gate to Drain Charge	Qgd	ID = -20 A		10		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 20 A, VGS = 0 V		0.95		V
Reverse Recovery Time	trr	IF = 20 A, VGS = 0 V		49		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		100		nC

Note Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2%

TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME

≶R∟ 1

Vdd

Vgs

Wave Form

Vos Wave Form Vgs (-)

VDS (-)

Vds

0

td(on)

ton

0 10%

90%

90%

tf

toff

Vgs

10% 10%

tr td(off)

D.U.T.

RG

τ

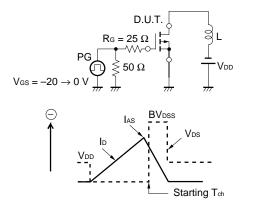
Duty Cycle $\leq 1\%$

 $\tau = 1 \, \mu s$

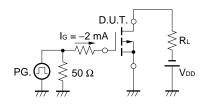
PG

Vgs (-)

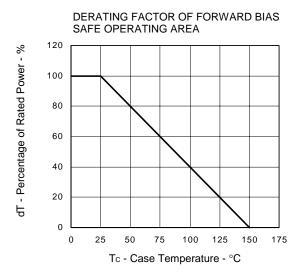
0.

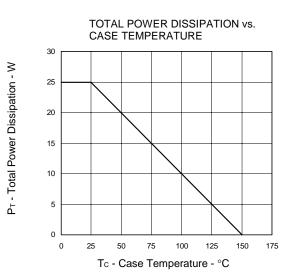


TEST CIRCUIT 3 GATE CHARGE

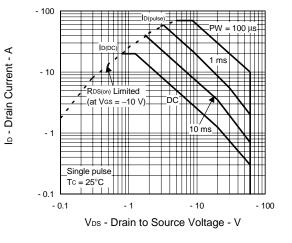


TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

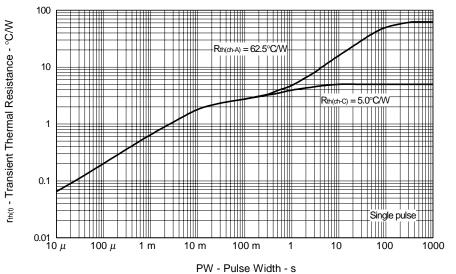




FORWARD BIAS SAFE OPERATING AREA



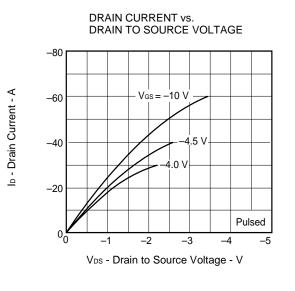




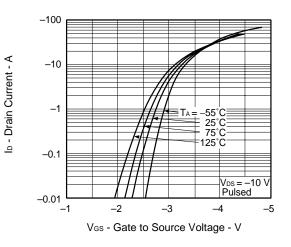
Data Sheet D16332EJ1V0DS

-4.0

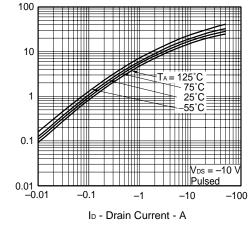
V_{GS(off)} - Gate Cut-off Voltage - V

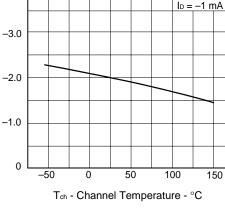


FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



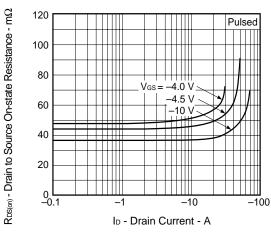


GATE CUT-OFF VOLTAGE vs.

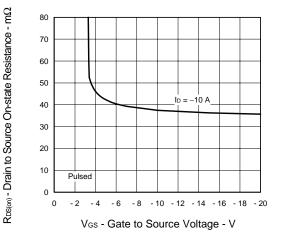
 $V_{DS} = -10 V$

CHANNEL TEMPERATURE

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

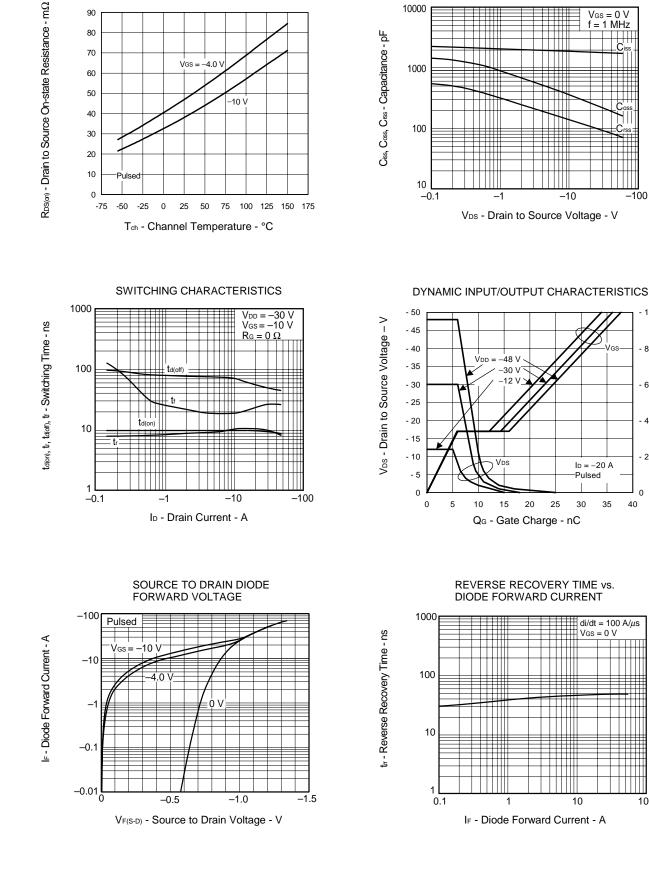


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 \mid yrs \mid - Forward Transfer Admittance - S

10000



NEC

90

80

70

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

CHANNEL TEMPERATURE

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

2SJ649

V_{GS} = 0 V f = 1 MHz

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- 10

- 8

- 6

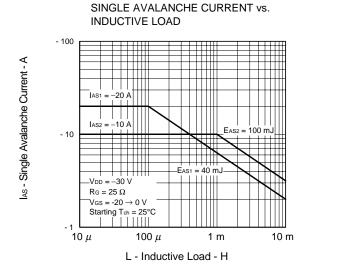
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- 2

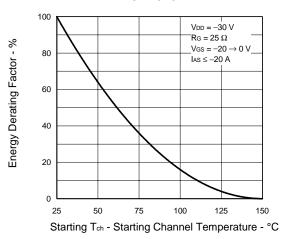
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Vgs - Gate to Source Voltage - V

100

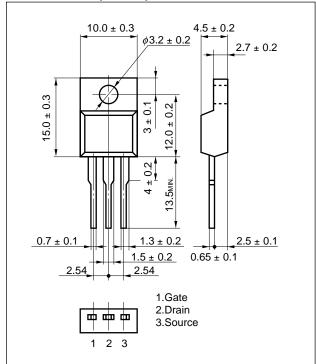


SINGLE AVALANCHE ENERGY DERATING FACTOR

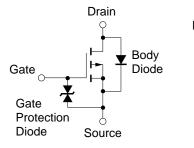


PACKAGE DRAWING (Unit: mm)

Isolated TO-220 (MP-45F)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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